

DECLARATION FOR PATENT APPLICATION

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first, and sole inventor (if only one name is listed below) or an original, first, and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled **SYSTEM AND METHOD FOR ACCESS POINT (AP) AGGREGATION AND RESILIENCY IN A HYBRID WIRED/WIRELESS LOCAL AREA NETWORK**, the specification of which

(check one) ☒ is attached hereto.

☐ was filed on _____, 200X as Application Serial No. _____, was amended on _____, and issued on _____ as U.S. Patent No. _____.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information that is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, §119(a)-(d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

PRIOR FOREIGN APPLICATION(S)			<u>Priority Claimed</u>
			Yes/No
(Number)	(Country)	(Date Filed)	
60/435,977			December 20, 2002
60/411,261			September 17, 2002
60/411,301			September 17, 2002
60/435,984			December 20, 2002
(Application Serial No.)			(Filing Date)

I hereby claim the benefit under Title 35, United States Code, §119(e) of any United States provisional application(s) listed below:

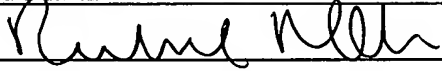
I hereby claim the benefit under Title 35, United States Code, §120 of any United States application or any international application designating the United States under Title 35, United States Code, §365 listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56, regarding events which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Number)	(Country)	(Date Filed)
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(Number)	(Country)	(Date Filed)
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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

First named inventor:

Full name Richard Martin
Inventor's Signature  Date 6-18, 2003
Residence 19097 Eagleview Drive, Morgan Hill, CA 95037 Citizenship Canadian
Post Office Address _____

Second named inventor:

Full name Yong Kim

Inventor's Signature  Date 8/22, 2003

Residence 7114 Glenview Drive, San Jose CA 95120 Citizenship USA

Post Office Address _____